

**Amendments to the Claims:**

This listing of the claims replaces the listings of the claims in the present patent application:

**Listing of Claims:**

1. **(Currently Amended)** An audio playback device interface for interface with an audio headset, said interface comprising:

a load in series between an audio output of a stereo headset driver of an audio playback device and a ground, wherein the load is configured to prevent the audio output from directly contacting a ground when a mono headset plug is inserted into the stereo headset driver of the audio playback device, the load configured to reduce current draw from a power supply corresponding to the playback device when a mono headset is plugged into a headset jack of the playback device;

a headset driver electrically coupled to the load, wherein the load resistance is at least equal to the minimum impedance that the headset driver is configured to drive; and

a second load resistance equal to the first load, the second load in series between a second audio output of a stereo headset driver and a headset jack of an audio playback device.

2. **(Cancelled)**

**3. (Currently Amended)** An audio playback device comprising:

    a stereo headset driver for amplifying a first and a second audio signal to a headset;

    a headset jack for contacting a headset plug in communication with a headset, said headset jack in communication with output from said stereo headset driver; and

    a load between said headset jack and a first audio output from said stereo headset driver for preventing a first audio output from contacting a ground when a mono headset plug is inserted into the stereo headset driver of the audio playback device, wherein the load is configured to reduce current draw from a power supply corresponding to the playback device when the mono headset is plugged into the headset jack of the playback device.

**4. (Previously Presented)** The audio playback device of claim 3 wherein said load comprises a resistance in series between a first audio output from said stereo headset driver and the ground.

**5. (Original)** The audio playback device of claim 3 further comprising a second load between said headset jack and a second audio output from said stereo headset driver.

**6. (Original)** The audio playback device of claim 5 wherein the resistance of said second load is equal to the resistance of said first load.

**7. (Original)** The audio playback device of claim 5 wherein said second load comprises a resistance in series between a second audio output from said stereo headset driver and said headset jack.

8. **(Currently Amended)** A mobile communication device comprising:

    a stereo headset driver for amplifying a first and a second audio signal to a headset;

    a headset jack for contacting a headset plug in communication with a headset, said headset jack in communication with output from said stereo headset driver; and

    a load between said headset jack and a first audio output from said stereo headset driver for preventing a first audio output from contacting a ground when a mono headset plug is inserted into the stereo headset driver of the audio playback device, wherein the load is configured to reduce current draw from a power supply corresponding to the playback device when the mono headset is plugged into the headset jack of the communication device.

9. **(Currently Amended)** A method of making a stereo audio playback device compatible with stereo and mono headsets comprising:

    providing a headset driver for the audio playback device for amplifying a first and a second audio signal to a headset; [[and]]

    placing a load on a first audio output from the headset driver to prevent a first audio output from contacting a ground on a headset plug when a mono headset plug is inserted into the stereo headset driver of the audio playback device, wherein the load is configured to reduce current draw from a power supply corresponding to the playback device when the mono headset is plugged into the headset jack of the playback device;

placing another load between a second audio output from the headset driver and a headset jack of the audio playback device; and

matching the values of the two loads.

10. **(Original)** The method of claim 9 wherein placing a load on a first audio output comprises placing a resistance in series between a first audio output from the stereo headset driver and a ground.

11. **(Cancelled)**

12. **(Currently Amended)** The method of claim 10 [[11]] wherein placing a load on a second audio output comprises placing a resistance in series between a second audio output from the stereo headset driver and a headset jack.

13. **(Cancelled)**

14. **(Previously Presented)** The method of claim 4 wherein said resistance is equal to or greater than a minimum impendence or resistance which said headset driver is configured to drive.

15. **(Previously Presented)** The method of claim 10 wherein said resistance is equal to or greater than a minimum impendence or resistance which said headset driver is configured to drive.